

Title (en)

SUPPORT FOR AUDIO SYSTEM AND AUDIO INSTALLATION COMPRISING SUCH A SUPPORT

Title (de)

BASIS FÜR AUDIOSYSTEM UND AUDIOEINRICHTUNG MIT EINER SOLCHEN BASIS

Title (fr)

SUPPORT POUR SYSTÈME AUDIO ET INSTALLATION AUDIO COMPORTANT UN TEL SUPPORT

Publication

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Application

EP 14814841 A 20141216

Priority

- FR 1363570 A 20131224
- EP 2014078025 W 20141216

Abstract (en)

[origin: WO2015097023A1] The invention relates to a mounting (4) for an audio system (2), the audio system (2) comprising a heat source (6), a heat-discharge surface (12) and means (14) for guiding at least part of the heat produced by the heat source (10) towards the discharge surface (12), the mounting (4) being characterised in that it comprises a plate (16) including at least one heat-conductive resilient member (26) capable of deforming such as to match at least part of the discharge surface (14) of the audio system (2), and a heat-sink radiator (18) in thermal contact with the resilient member (26).

IPC 8 full level

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